# NSR10F20MXT5G

# **Schottky Barrier Diode**

These Schottky barrier diodes are optimized for low forward voltage drop and low leakage current and are offered in a Chip Scale Package (CSP) to reduce board space. The low thermal resistance enables designers to meet the challenging task of achieving higher efficiency and meeting reduced space requirements.

#### Features

- Low Forward Voltage Drop 430 mV @ 1.0 A
- Low Reverse Current 20 μA @ 10 V VR
- 1.0 A of Continuous Forward Current
- ESD Rating Human Body Model: Class 3B
- Machine Model: Class C
- High Switching Speed
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### **Typical Applications**

- LCD and Keypad Backlighting
- Camera Photo Flash
- Buck and Boost dc-dc Converters
- Reverse Voltage and Current Protection
- Clamping & Protection

#### Markets

- Mobile Handsets
- MP3 Players
- Digital Camera and Camcorders
- Notebook PCs & PDAs
- GPS

## MAXIMUM RATINGS

Rating		Symbol	Value	Unit	
Reverse Voltage		V <sub>R</sub>	20	V	
Forward Current (DC)		١ <sub>F</sub>	1.0	А	
Forward Surge Current (60 Hz @ 1 cycle)		I <sub>FSM</sub>	18	А	
ESD Rating:	Human Body Model Machine Model	ESD	> 8 > 400	kV V	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

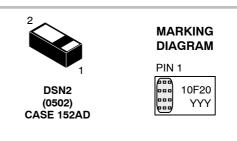


## **ON Semiconductor®**

http://onsemi.com

# 20 V SCHOTTKY BARRIER DIODE

1 0 2 CATHODE ANODE



10F20 = Specific Device Code YYY = Year Code

#### **ORDERING INFORMATION**

Device	Package	Shipping†
NSR10F20NXT5G	DSN2 (Pb-Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## 查爾MAGROWARDACTED的智ICS

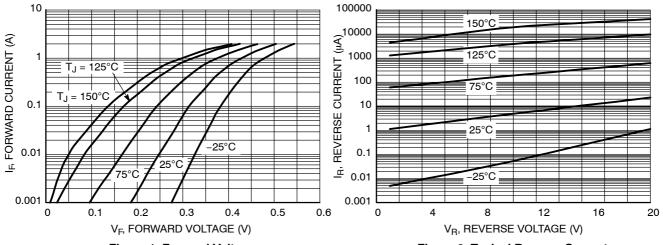
Characteristic	Symbol	Min	Тур	Max	Unit
Thermal Resistance Junction-to-Ambient (Note 1) Total Power Dissipation @ T <sub>A</sub> = 25°C	R <sub>θJA</sub> P <sub>D</sub>			228 548	°C/W mW
Thermal Resistance Junction-to-Ambient (Note 2) Total Power Dissipation @ T <sub>A</sub> = 25°C	R <sub>θJA</sub> PD			85 1.47	°C/W W
Storage Temperature Range	T <sub>stg</sub>			-40 to +125	°C
Junction Temperature	TJ			+150	°C

1. Mounted onto a 4 in square FR-4 board 50 mm sq. 1 oz. Cu 0.06" thick single sided. Operating to steady state.

2. Mounted onto a 4 in square FR-4 board 1 in sq. 1 oz. Cu 0.06" thick single sided. Operating to steady state.

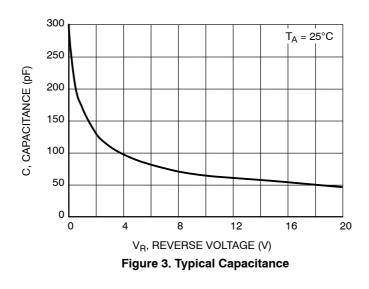
#### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Leakage $(V_R = 10 \text{ V})$ $(V_R = 20 \text{ V})$	I <sub>R</sub>			20 100	μΑ
Forward Voltage (I <sub>F</sub> = 0.5 A) (I <sub>F</sub> = 1.0 A)	V <sub>F</sub>		0.380 0.430	0.400 0.450	V





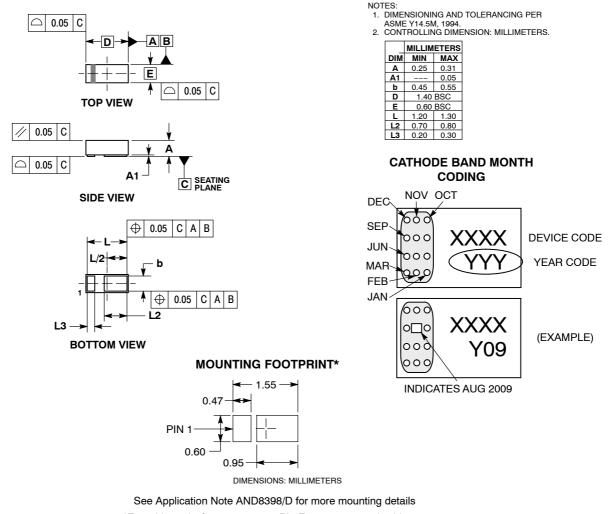




## 查询"NSR10F20"供应商

#### PACKAGE DIMENSIONS

DSN2, 1.4x0.6, 0.75P CASE 152AD-01 ISSUE A



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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